TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

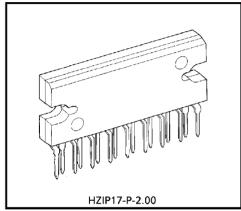
TA8220H

30W BTL × 2CH AUDIO POWER AMPLIFIER

The thermal resistance θ_i -T of TA8220H package designed for low thermal resistance, has high efficiency of heat radiation.

The temperature rise of chip can be reduced, and the influence from the degradation of the features due to the temperature rise at the high output can also be reduced.

This stereo audio power IC, designed for car audio use, has two built-in channels to reduce the Characteristic difference between L and R channels. It also contains output short detection circuit, output clip detection and various kind of protection.



Weight: 9.8g (Typ.)

FEATURES

- Low Thermal Resistance : $\theta j-T = 1.5^{\circ}C/W$ (Infinite Heat Sink)
- High Power: $P_{OUT}(1) = 30W (Typ.) / Channel$

 $(V_{CC} = 14.4V, f = 1kHz, THD = 10\%, R_L = 2\Omega)$

: POUT (2) = 26W (Typ.) / Channel

 $(V_{CC} = 13.2V, f = 1kHz, THD = 10\%, R_L = 2\Omega)$

: POUT (3) = 19W (Typ.) / Channel ($V_{CC} = 13.2V$, f = 1kHz, THD = 10%, $R_L = 4\Omega$)

: THD = 0.04% (Typ.) Low Distortion Ratio

 $(V_{CC} = 13.2V, f = 1kHz, P_{OUT} = 1W, R_L = 4\Omega, G_V = 50dB)$

Low Noise

: V_{NO} = 0.30m V_{rms} (Typ.) (V_{CC} = 13.2V, R_L = 4Ω , G_V = 50dB, R_g = 0Ω , BW = 20Hz~20kHz)

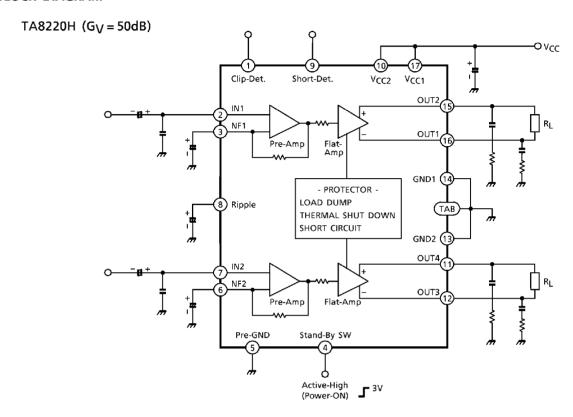
- Built-in Stand-by Function (With e pin set at LOW, power is turned OFF.) : $I_{SB} = 1\mu A$ (Typ.)
- Built-in Output Short Detection Circuit (9pin: Open Collector)
- Built-in Output Clip Detection Circuit (①pin: Open Collector)
- **Built-in Various Protection Circuits** Protection Circuits: Thermal Shut Down, Over Voltage, Out→VCC Short, Out→GND Short and OUT-OUT Short.
- Operating Supply Voltage : $V_{CC} = 9 \sim 18V$

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 The product is often the final stage (the external output stage) of a circuit. Substandard performance or malfunction

- of the destination device to which the circuit supplies output stage) of a circuit. Substandard performance or malfunction of the destination device to which the circuit supplies output may cause damage to the circuit or to the product. The products described in this document are subject to foreign exchange and foreign trade control laws. The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
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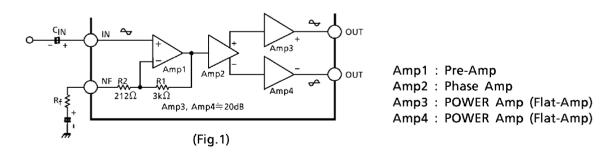
BLOCK DIAGRAM



CAUTION AND APPLICATION METHOD

(Description is made only on the single channel.)

1. Voltage gain adjustment



This IC has the amplifier constructions as shown Fig.1. The Pre-Amp (Amp1) is provided to the primary stage, and the input voltage is amplified by the Flat Amps, Amp3 and Amp4 of each channel through the phase Amp (Amp2).

Since the input offset is prevented by Pre-Amp when V_{CC} is set to ON, this circuit can remarkably reduce the pop noise.

The total closed loop gain G_V of this IC can be obtained by expression below when the closed loop voltage gain of Amp1 is G_{V1} .

$$G_{V1} = 20 log \frac{R1 + (R_f + R2)}{R_f + R2} (dB) \cdots (1)$$

The closed loop voltage gain of POWER Amp, Amp3 and Amp4 is fixed at $G_{V3} = G_{V4} = 20$ dB. Therefore, the total closed circuit voltage gain G_V is obtained through BTL connection by the expression below.

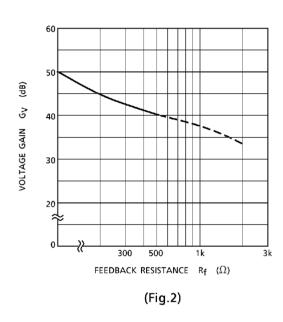
$$G_V = G_{V1} + G_{V3} + 6 \text{ (dB)} \cdots (2)$$

For example, when $R_f = 0\Omega$, G_V is obtained by the expressions (1) and (2) as shown below.

$$G_V = 24 + 20 + 6 = 50 dB$$

The voltage gain is reduced when Rf is increased. (Fig.2)

With the voltage gain reduced, since (1) the oscillation stability is reduced, and (2) the pop noise changes when V_{CC} is set to ON, refer to the items 3 and 4.

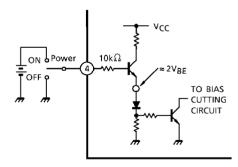


2. Stand-by SW function

By means of controlling a pin (Stand-by terminal) to High and Low, the power supply can be set to ON and OFF. The threshold voltage of a pin is set at 2.1V (3VBE), and the Power Supply current is about $1\mu\text{A}$ (Typ.) at the stand-by state.

Control Voltage of @pin : V (SB)

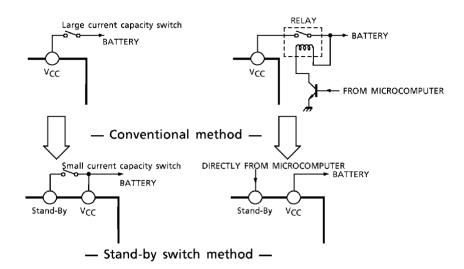
Stand-By	Power	V (SB) (V)
ON	OFF	0~2
OFF	ON	3~V _{CC}



(Fig.3)With @pin set to high, power is turned ON.

<Adjustage of stand-by SW>

- (1) Since V_{CC} can directly be controlled to ON/OFF by the microcomputer, the switching relay can be omitted.
- (2) Since the control current is microscopic, the switching relay of small current capacity is satisfactory for switching.



3. Preventive measure against oscillation

For preventing the oscillation, it is advisable to use C4, the condenser of polyester film having small characteristic fluctuation of the temperature and the frequency.

The condenser (C6) between input and GND is effective for preventing oscillation which is generated with a feedback signal from a output stage.

The resistance R to be series applied to C4 is effective for phase correction of high frequency, and improves the oscillation allowance.

- (1) Voltage gain to be used (G_V setting)
- (2) Capacity value of condenser
- (3) Kind of condenser
- (4) Layout of printed board

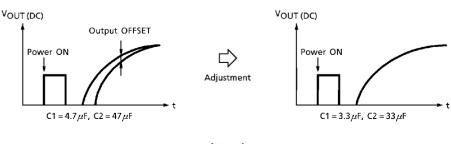
In case of its use with the voltage gain G_V reduced or with the feedback amount increased, care must be taken because the phase-inversion is caused by the high frequency resulting in making the oscillation liable generated.

4. Adjustment of output offset (When the power supply turn on)

As this IC is constructed with DC circuit on the Pre-Amp stage, it is necessary to lower a input offset or output offset by agreement with the each leading edge time constant of the input voltage in the Pre-Amp stage and NF terminal voltage.

Concretely, monitor the output DC voltage and vary the capacity value in input condenser and NF condenser (See Fig.4)

(Reference) In case of setting the condition (GV = 40dB) with R_f = 470 Ω .



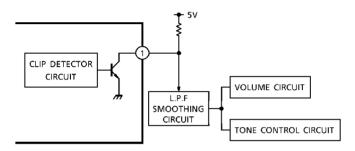
(Fig.4)

5. Output clip detection function (Pin ①)

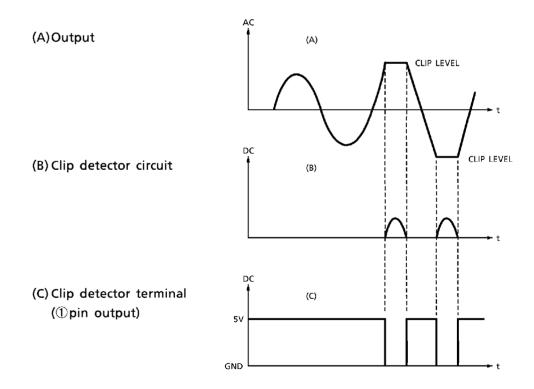
The output clip detection terminal of pin ① has the open collector output structure on clip as shown in Fig.5. In case that the output waveform is clipping, the clip detection circuit is operated and NPN Tr. is turned on.

It is possible to improve the tone quality with the current of flowing into pin ① and with controlling the volume, tone control circuit through L.P.F smoothing circuit as shown in Fig.5. In case of being unused this function, use this IC as open connection on pin ①.

(Application)



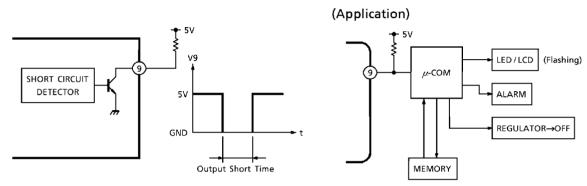
(Fig.5) ①pin: Open collector output (Active low)



6. Output to V_{CC} , output to GND detection function (Pin \P)

The Output Short Detection Terminal of pin (9) has open collector output structure on chip as shown in Fig.6.

In unusual case that output terminal of Power Amp. is condition of output to V_{CC} or Output to GND Short, it is possible to protect all the system of apparatus as well as Power IC protection. In case of being unused this function, use this IC as open-connection on pin \mathfrak{G} .



(a) pin : Open Collector Output (Active Low)
(Fig.6)

7. External part list and description

			INFLU			
SYM- BOL	RECOMMENDED VALUE	FEATURE	SMALLER THAN RECOMMENDED VALUE	LARGER THAN RECOMMENDED VALUE	REMARKS	
C1	4.7 μF	DC blocking	Related to pop noise at V _{CC} →ON.		Related to gain. Refer to item 4.	
C2	47μF	Feedback condenser	Related to pop noise at $V_{CC}\rightarrow ON$. Determination of low cut-off frequency $C2 = \frac{1}{2\pi \cdot f_L \cdot R_f}$			
C3	220 μF	Ripple reduction	Time constant is small at V _{CC} →ON or OFF.	Time constant is large at V _{CC} →ON or OFF.		
C4	0.12 <i>μ</i> F	Oscillation prevention	Made liable to oscillate.	Oscillation allowance	Refer to item 3.	
C5	1000 <i>μ</i> F	Ripple filter	For filtering power supply hum and ripple. Large at using AC rectified power supply. Small at using DC power supply.			
C6	1000pF	Oscillation prevention	Oscillation allowance improved. Noise Reduction		Refer to item 3.	

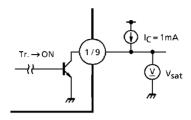
MAXIMUM RATINGS (Ta = 25° C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Peak Input Voltage (0.2s)	V _{IN (surge)}	50	V
DC Supply Voltage	VIN (DC)	25	V
Operating Supply Voltage	V _{IN (opr)}	18	٧
Output Current (Peak)	I _{O (peak)}	9	٧
Power Dissipation	PD	50	W
Operating Temperature	Topr	- 30~85	°C
Storage Temperature	T _{stg}	- 55~150	°C

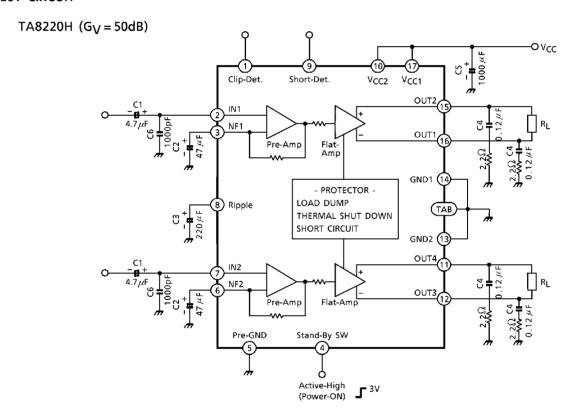
ELECTRICAL CHARACTERISTICS (Unless otherwise specified, $V_{CC} = 13.2V$, $R_L = 4\Omega$, f = 1kHz, $Ta = 25^{\circ}C$)

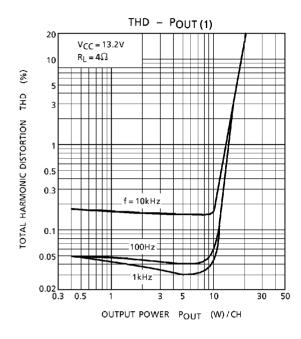
ELLETHICAL CHARACTERISTICS (Offices Streetwise specified, VCC = 13.24, RE = 422, T = 18.12, Td = 23.5)								
CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.		MAX.	UNIT	
Quiescent Supply Current	lccq	_	V _{IN} = 0	_	120	250	mA	
Output Power	POUT (1)		$V_{CC} = 14.4V, R_{L} = 2\Omega,$ THD = 10%	_	30	_	W	
	POUT (2)	_	$R_L = 2\Omega$, THD = 10%	17	26	—	**	
	POUT (3)	_	THD = 10%	16	19	_		
Total Harmonic Distortion Ratio	THD	_	P _{OUT} = 1W	_	0.04	0.4	%	
Voltage Gain	GV	_		48	50	52	dB	
Voltage Gain Ratio	⊿G _V	_		- 1.0	0	1.0	dB	
Output Noise Voltage	v_{NO}	_	$R_g = 0\Omega$, BW = 20Hz~20kHz	_	0.3	0.7	mV _{rms}	
Ripple Rejection Ratio	R.R.	_	$f_{ripple} = 100Hz, R_g = 600\Omega$	40	54	_	dB	
Input Resistance	R _{IN}	_		_	30	_	kΩ	
Output Offset Voltage	Voffset	_	V _{IN} = 0	- 100	0	100	mV	
Current at Standard-By State	ISB	_		_	1	10	μΑ	
Cross Talk	C.T.	_	$R_g = 600\Omega$, $V_{OUT} = 0.775V_{rms}$ (0dBm)	_	60	_	dB	
⊕pin Control Voltage	V _{SB}	_	Stand-By→OFF (Power→ON)	2.5	_	Vcc	٧	
①pin (CLIP DET) Saturation Voltage	V _{sat ①}	_	I _C = 1mA	_	100	_	mV	
<pre></pre>	V _{sat} ⑨	_	I _C = 1mA	_	100	_	mV	

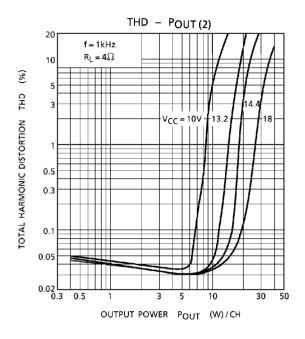
v_{sat} , v_{sat} TEST CIRCUIT

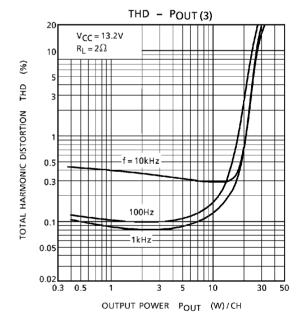


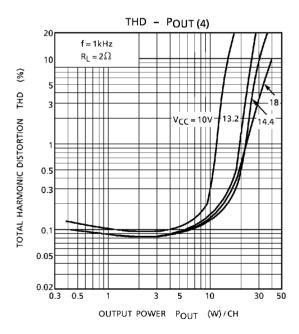
TEST CIRCUIT

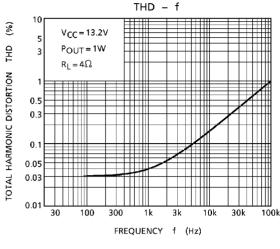


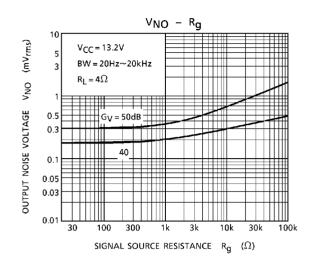


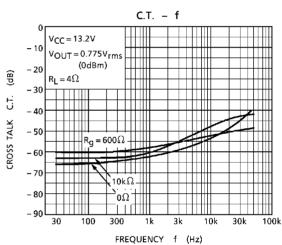


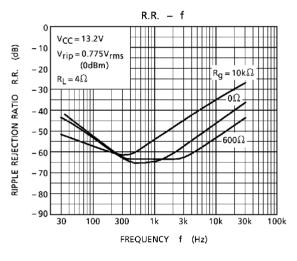


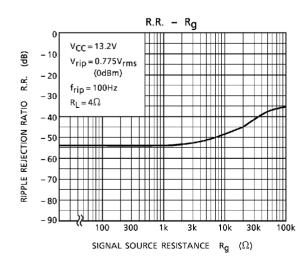


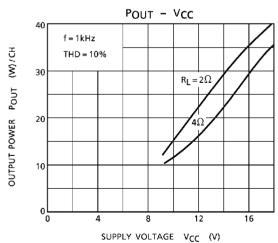


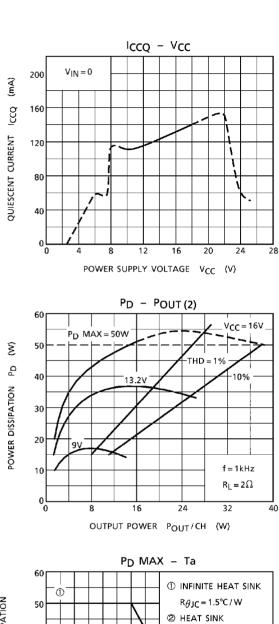


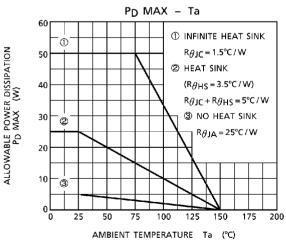


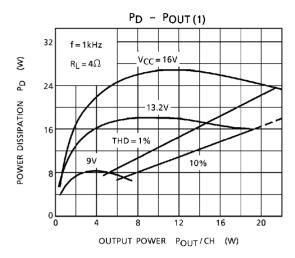


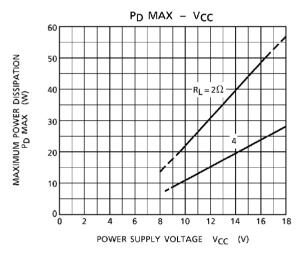






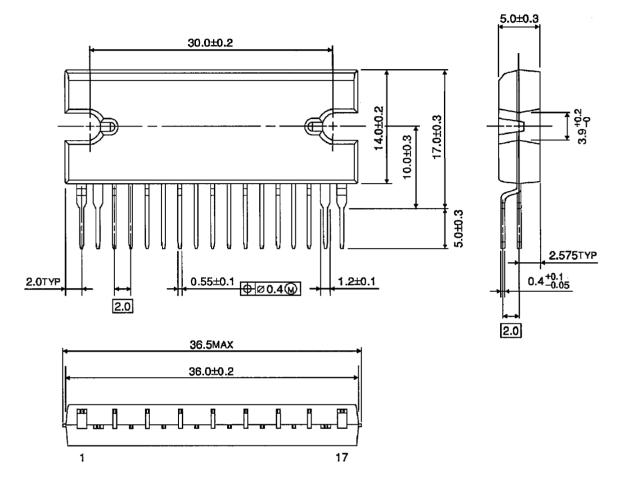






OUTLINE DRAWING

HZIP17-P-2.00



Weight: 9.8g (Typ.)